

Sentris IC 600-XYZZ with Probing Platform enclosed by the Benchtop Test Enclosure 600 Series with clear panels.



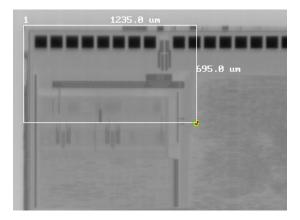
- · Complete, turn-key systems
- · Detect localized heating < 0.0001°C
- · Defect depth analysis of stacked die
- True temperature mapping using Emissivity Tables
- · Visual camera probing
- · Front and backside analysis
- $\boldsymbol{\cdot}$ No need for surface treatment or coating

Sentris IC

Electronics Failure Analysis System

Sentris pinpoints low-level infrared thermal emissions from faults such as short circuits and leakage current.

Lock-in Thermography (LIT) is a non-destructive process of automatically and repeatedly powering an electronic device at regular intervals while thermal images of the device are analyzed by software. Failures can be isolated on both bare (front or backside) and packaged devices without the need for surface treatment or coating.





The Freestanding Test Enclosure 600 contains a 19" standard 18U rack, locking casters, and light tree, in addition to the basic enclosure features listed below.

Applications

Faults Detected

- · Semiconductor ESD related faults
- Leakage current and Resistive shorts
- Latch-up sites
- Defective transistors and diodes
- · Oxide layer breakdown
- · SMD component leakage

Testable Electronic Devices

- Bare semiconductor devices
- Package semiconductor devices
- · Wafers
- · SMD components
- · Bare circuit boards
- Populated circuit boards
- · Flex circuits

Options

- · Camera positioning system with automatic or manual X,Y, and/or Z axes.
- Optional components include Thermoelectric Stages and Controllers, Device Probing Platform, Motor Controller Safety Kit, Needle Probers, etc.
- Enclosures feature an electrical control box; a passthrough panel for banana Jack, BNC, and TRIAX connections; a door activated N.O and N.C. interlock system with auxiliary screw terminals; etc.

Thermalyze Image Analysis Software Capabilities

In addition to Lock-in Thermography, Thermalyze provides an extensive set of analysis tools to help you characterize the performance of electronic and micro-mechanical devices in many different and insightful ways.

Image Overlay		Import pictures or schematics to overlay with thermal images and lock-in hot spots	
Image Subtraction		Analyze delta temperature from an unpowered state	
Emissivity Tables		Emissivity correction by regions or pixel by pixel to compensate for surface emissivity variations	
Instrument Control		Direct control of specific Tektronix source meters during lock-in tests	
Sequence	S	Create movies of thermal events for post-test analysis	
Regions		Draw regions to display temperature statistics	
Graphs		Real time line profiles, histograms, and strip charts of temperature statistics	
Linear Stag Control	ge	Direct control of linear stage positioning, speed, and safety settings	

IS640-17 LWIR Camera, 60Hz Specifications

Observe real time thermal behavior with Optotherm's radiometric camera that measures temperature accurately.

Infrared Detector	Uncooled vanadium oxide microbolometer
Array Size	640 x 480 pixels
Detector Pitch	17μm
Noise Equivalent Temperature Difference	< 30 mK (< 12 mK with ≤9 Hz option)
Spectral Response	7-14 µm
Thermal Time Constant	< 11 ms
Compatible lenses*	Масго, 80µm, 40µm, 20µm, 10µm, 5µm†
Accuracy of radiometric lenses (Macro, 80µm, 20µm, 10µm)	Low range: +/-2°C High range: +/-2°C or 2% of reading §

* All lenses are radiometric except 40 μm & 5 μm

† Lens size " μ m" indicates pixel resolution



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